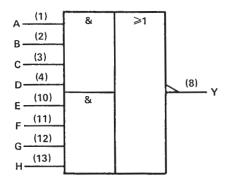
- Package Options Include "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

These devices contain 2-wide 4-input AND-OR-INVERT gates. They perform the Boolean function $Y = \overline{ABCD + EFGH}$.

The SN54LS55 is characterized for operation over the full military temperature range of $-55\,^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$. The SN74LS55 is characterized for operation from 0 $^{\circ}\text{C}$ to 70 $^{\circ}\text{C}$.

logic symbol†

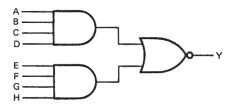


positive logic: $Y = \overline{ABCD + EFGH}$

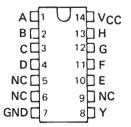
[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

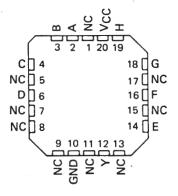
logic diagram



SN54LS55 . . . J OR W PACKAGE SN74LS55 . . . D OR N PACKAGE (TOP VIEW)

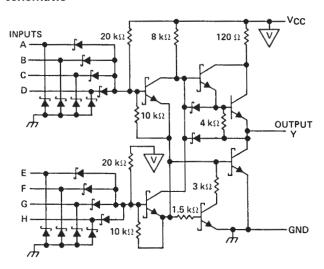


SN54LS55 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

schematic



Resistor values shown are nominal.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note	1)	7 V
Input voltage		7 V
Operating free-air temperature:	SN54LS55	-55°C to 125°C
	SN74LS55	0°C to 70°C
Storage temperature range		-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		S	SN54LS55		SN74LS55			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
ГОН	High-level output current			- 0.4			- 0.4	mA
loL	Low-level output current			4			. 8	mA
TA	Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN54LS55	SN74LS55	UNIT
	TEST CONDITIONS!	MIN TYP# MAX	MIN TYP\$ MAX	
v_{iK}	$V_{CC} = MIN$, $I_1 = -18 \text{ mA}$	- 1.5	- 1.5	V
Voн	$V_{CC} = MIN$, $V_{IL} = MAX$, $I_{OH} = -0.4 \text{ mA}$	2.5 3.4	2.7 3.4	V
VOL	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 4 mA	0.25 0.4	0.25 0.4	v
	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 8 mA		0.35 0.5	
l _l	VCC = MAX, VI = 7 V	0.1	0.1	mA
Чн	VCC = MAX, VI = 2.7 V	20	20	μА
HL	VCC = MAX, VI = 0.4 V	0.4	-0.4	mA
los§	VCC = MAX	- 20 - 100	-20 -100	mA
Іссн	VCC = MAX, VI = 0 V	0.4 0.8	0.4 0.8	mA
ICCL	V _{CC} = MAX, See Note 2	0.7 1.3	0.7 1.3	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
^t PLH	Any	Y	$R_1 = 2 k\Omega$	C ₁ = 15 pF		12	20	ns
^t PHL				о[- 15 рг		12.5	20	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ} \text{C}$.

[§]Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

NOTE 2: All outputs of one AND gate at 4.5 V, all others at GND.

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